

S. Patent Feb. 11, 2003 Sheet 2 of 3 US 6,518

FIG. 2

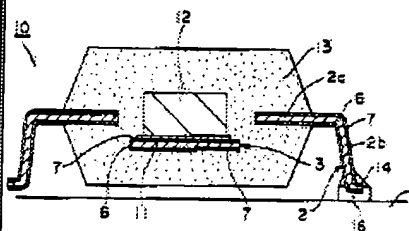
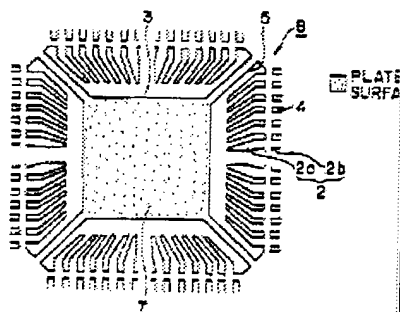


FIG. 3



US-PAT-NO: 6518653

DOCUMENT-IDENTIFIER: US 6518653 B1

TITLE: Lead frame and semiconductor device

DATE-ISSUED: February 11, 2003

INVENTOR-INFORMATION:

NAME	CITY	STATE	ZIP CODE	COUNTRY
Takagi, Saeko	Oita	N/A	N/A	JP

ASSIGNEE INFORMATION:

NAME	CITY	STATE	ZIP CODE	COUNTRY	TYPE CO
Sony Corporation	N/A	N/A	N/A	JP	03

APPL-NO: 09/ 328260

DATE FILED: June 10, 1999

FOREIGN-APPL-PRIORITY-DATA:

COUNTRY	APPL-NO	APPL-DATE
JP	10-166441	June 15, 1998

Advanced Find

Find what: 52

Area

☐ All

☒ Sel/Cur

Direction

☐ Up

☒ Down

Match word

☐ Whole

☒ Part

☐ Left

☐ Right

Look in

☐ Grid

☒ Documents

Find Next

Cancel

☐ Match case

Title

Lead frame and semiconductor device

Lead frame and semiconductor device

Lead frame and semiconductor device